## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

in re Application of:	)
Tsuyoshi ARUGA et al.	) Oroup Art Unit: Not Yet Assigned
Application No.: <b>10/563,131</b>	) Confirmation No.: <b>8038</b>
Filed: January 3, 2006	) )
National Stage of International Application No. PCT/JP2004/009160 under 35 U.S.C. 371, for BONDING METHOD AND BONDING APPARATUS	) ) ) )

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

## SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. § 1.97(b)

Pursuant to 37 C.F.R. §§1.56 and 1.97(b), applicants bring to the Examiner's attention the documents listed on attached Form PTO/SB/08. Copies of the listed documents are attached. Applicants respectfully request that the Examiner consider the documents listed on attached Form PTO/SB/08 and indicate that they were considered by making an appropriate notation on this form. This Supplemental Information Disclosure Statement is being filed before the mailing date of a first Office Action on the merits for the above-referenced application.

The following is listed on the accompanying PTO/SB/08 and is in a non-English language:

 Japanese Patent Laid-Open Publication No. 2001-053218 - The relevance of this document is discussed at page 1 of the specification of the present application.
 An English language abstract of this document is also enclosed. This submission does not represent that a search has been made or that no better art exists and does not constitute an admission that each or all of the listed documents are material or constitute "prior art." If the Examiner applies any of the documents as prior art against any claim in the application and applicants determine that the cited documents do not constitute "prior art" under United States law, applicants reserve the right to present to the Office the relevant facts and law regarding the appropriate status of such documents. Applicants further reserve the right to take appropriate action to establish the patentability of the disclosed invention over the listed documents, should one or more of the documents be applied against the claims of the present application.

If there is any fee due in connection with the filing of this Statement, please charge the fee to our Deposit Account No. 06-0916.

Respectfully submitted,

FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

Dated: May 30, 2006

Enclosures DWH/FPD/sci

David W. Hill Reg. No. 28,220

> ERNEST F. CHAPMAN Reg. No. 25,961

IDS Form PTO/SB/08: Substitute for form 1449A/PTO

## SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use	as many	sheets	as	necessary)	

Sheet	1	of	1

Complete if Known			
Application Number	10/563,131		
Filing Date	January 3, 2006		
First Named Inventor	Tsuyoshi ARUGA et al.		
Art Unit	Not Yet Assigned		
Examiner Name	Not Yet Assigned		
Attomey Docket Number	02887.0372		

	U.S. PATENTS AND PUBLISHED U.S. PATENT APPLICATIONS					
Examiner	Cite No. <sup>1</sup>	Document Number	Issue or	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where	
Initials		Number-Kind Code <sup>2</sup> (if known)	Publication Date MM-DD-YYYY		Relevant Passages or Relevant Figures Appear	
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		US-				
		US-			107	

Note: Copies of the U.S. Patent Documents are not Required in IDS filed after October 21, 2004

	FOREIGN PATENT DOCUMENTS						
Examiner Initials	Cite No. <sup>1</sup>	Foreign Patent Document  Country Code <sup>3</sup> Number <sup>4</sup> Kind Code <sup>5</sup> (# known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	Translation <sup>6</sup>	
/N.H.	/	JP 2001-053218	02-23-2001	TAKAHASHI et al.		ABSTRACT	
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	NON PATENT LITERATURE DOCUMENTS				
Examiner Initials	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	Translation <sup>6</sup>		
/N.H./		SASAKI, K. et al., "128Mbit NAND Flash Memory by Chip-on-Chip Technology with Cu Through Plug," 2001 ICEP Proceedings, pp. 39-43, (2001).			
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Examiner /Nickolas Harm/ (09/25/2009) Signature	Date Considered 09/25/2009	
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